

**Date: Thursday, March 20, 2008**

**Subject: X-Ray & AOI**

**Presentator: Joshua Petras, Yes Tech**

#	Suggested Technical Topics:	
1	Soldering issues with various PCB finishes	2
2	board & solder defect collection	2
3	Wave solder fixtures	1
4	Various versions of lead-free solder paste	1
5	Testing options - ICT/Functional/Flying Probe	1
6	Solder paste inspection	1
7	Package-on-Package, Bump Die	1
8	Lead-free reflow profiling	1
9	Integrated MES systems	1
10	Failure analysis on solder joints/micro cracks	1
11	ESD controls	1
12	Closed-loop process feedback	1
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